

Amendments to the Specification:

Please amend the title as follows:

STACKED MICROELECTRONIC DIES ~~AND METHODS FOR STACKING~~
MICROELECTRONIC DIES

Please amend the CROSS REFERENCE TO RELATED APPLICATION section on page one as follows:

This application is a divisional application of United States Patent Application No. 09/644,766 entitled "STACKED MICROELECTRONIC DIES AND METHODS FOR STACKING MICROELECTRONIC DIES," filed on August 23, 2000, now Patent No. , 6,607,937, issued August 19, 2003, which is incorporated herein by reference in its entirety.